



EN: This Datasheet/Document is presented by the manufacturer.

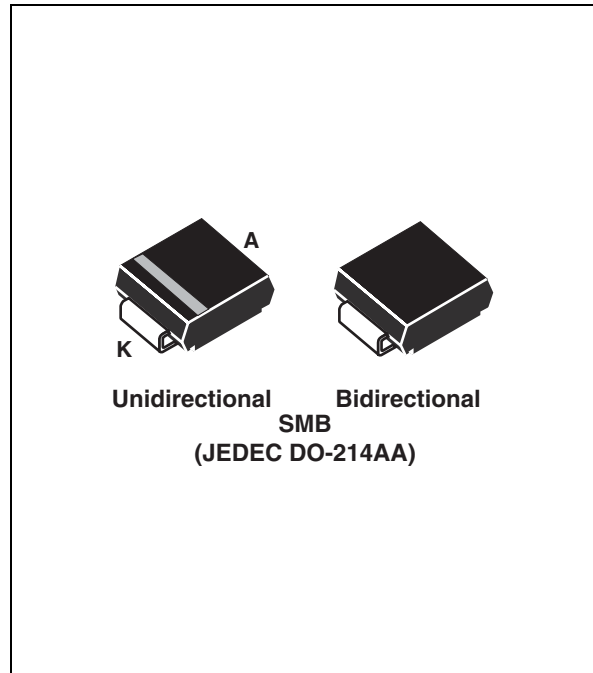
Please visit our website for pricing and availability at www.hestore.hu.

Features

- Peak pulse power:
 - 600 W (10/1000 μ s)
 - 4 kW (8/20 μ s)
- Breakdown voltage range: from 6.8 V to 220 V
- Unidirectional and bidirectional types
- Low leakage current:
 - 0.2 μ A at 25 °C
 - 1 μ A at 85 °C
- Operating $T_{j\max}$: 150 °C
- High power capability at $T_{j\max}$:
 - 515 W (10/1000 μ s)
- JEDEC registered package outline

Complies with the following standards

- IEC 61000-4-2 level 4:
 - 15 kV (air discharge)
 - 8 kV (contact discharge)
- IEC 61000-4-5
- MIL STD 883G, method 3015-7: class 3B:
 - 25 kV HBM (human body model)
- UL 497B, file number: QVGQ2.E136224
- Resin meets UL 94, V0
- MIL-STD-750, method 2026 solderability
- EIA STD RS-481 and IEC 60286-3 packing
- IPC 7531 footprint



Description

The SM6T Transil series has been designed to protect sensitive equipment against electrostatic discharges according to IEC 61000-4-2 and MIL STD 883, method 3015, and electrical overstress according to IEC 61000-4-4 and 5. These devices are more generally used against surges below 600 W (10/1000 μ s).

Planar technology makes these devices suitable for high-end equipment and SMPS where low leakage current and high junction temperature are required to provide reliability and stability over time.

SM6T are packaged in SMB (SMB footprint in accordance with IPC 7531 standard).

TM: Transil is a trademark of STMicroelectronics

1 Characteristics

Table 1. Absolute maximum ratings

Symbol	Parameter		Value	Unit
P _{PP}	Peak pulse power dissipation ⁽¹⁾	T _j initial = T _{amb}	600	W
T _{stg}	Storage temperature range		-65 to 150	°C
T _j	Operating junction temperature range		-55 to 150	
T _L	Maximum lead temperature for soldering during 10 s.		260	

1. For a surge greater than the maximum values, the diode will fail in short-circuit.

Table 2. Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-l)}	Junction to leads	20	°C/W
R _{th(j-a)}	Junction to ambient on printed circuit on recommended pad layout	100	°C/W

Figure 1. Electrical characteristics - definitions

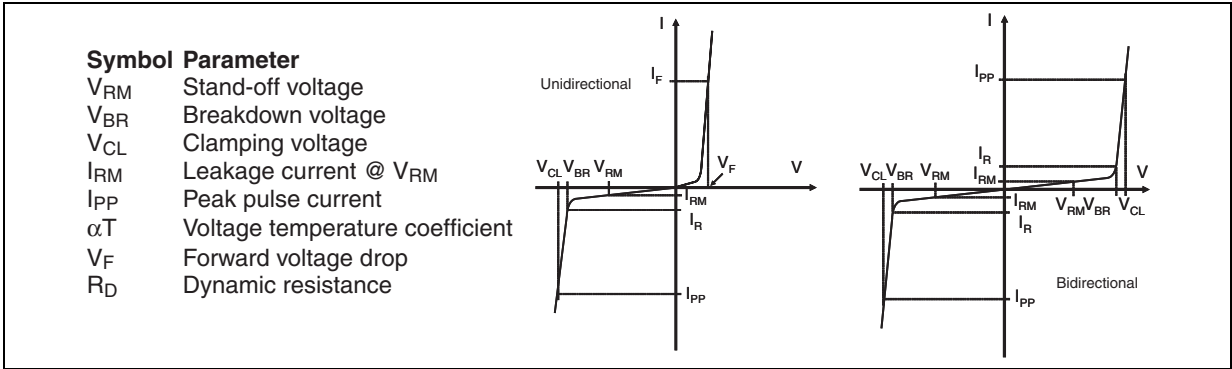


Figure 2. Pulse definition for electrical characteristics

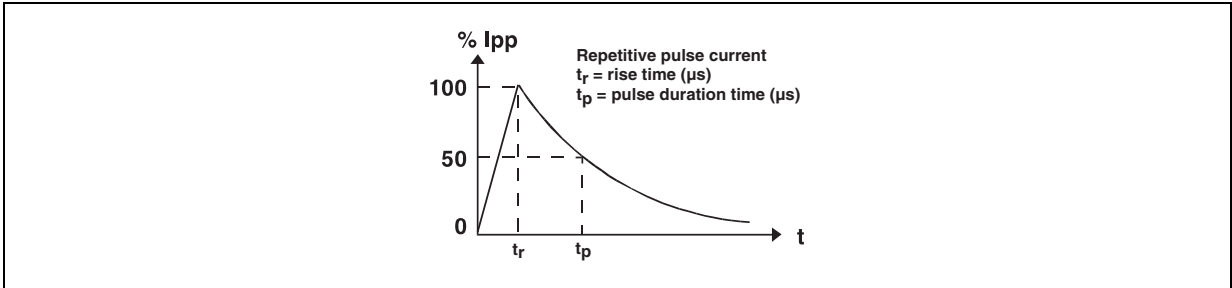


Table 3. Electrical characteristics, parameter values ($T_{amb} = 25\text{ }^{\circ}\text{C}$)

Order code	$I_{RM} \text{ max}@V_{RM}$			$V_{BR} @I_R^{(1)}$				$V_{CL} @I_{PP}$ 10/1000 μs		R_D 10/1000 μs	$V_{CL} @I_{PP}$ 8/20 μs		R_D 8/20 μs	$\alpha T^{(2)}$
	25 $^{\circ}\text{C}$	85 $^{\circ}\text{C}$		min	typ	max		max			max			max
	μA		V	V			mA	V ⁽³⁾	A ⁽⁴⁾	Ω	V ⁽³⁾	A ⁽⁴⁾	Ω	10-4/ $^{\circ}\text{C}$
SM6T6V8A/CA	20	50	5.8	6.45	6.8	7.14	10	10.5	57	0.059	13.4	298	0.021	5.7
SM6T7V5A/CA	20	50	6.4	7.13	7.5	7.88	10	11.3	53	0.065	14.5	276	0.024	6.1
SM6T10A/CA	20	50	8.55	9.5	10	10.5	1	14.5	41	0.098	18.6	215	0.038	7.3
SM6T12A/CA	0.2	1	10.2	11.4	12	12.6	1	16.7	36	0.114	21.7	184	0.049	7.8
SM6T15A/CA	0.2	1	12.8	14.3	15	15.8	1	21.2	28	0.193	27.2	147	0.078	8.4
SM6T18A/CA	0.2	1	15.3	17.1	18	18.9	1	25.2	24	0.263	32.5	123	0.111	8.8
SM6T22A/CA	0.2	1	18.8	20.9	22	23.1	1	30.6	20	0.375	39.3	102	0.159	9.2
SM6T24A/CA	0.2	1	20.5	22.8	24	25.2	1	33.2	18	0.444	42.8	93	0.189	9.4
SM6T27A/CA	0.2	1	23.1	25.7	27	28.4	1	37.5	16	0.569	48.3	83	0.240	9.6
SM6T30A/CA	0.2	1	25.6	28.5	30	31.5	1	41.5	14.5	0.690	53.5	75	0.293	9.7
SM6T33A/CA	0.2	1	28.2	31.4	33	34.7	1	45.7	13.1	0.840	59.0	68	0.357	9.8
SM6T36A/CA	0.2	1	30.8	34.2	36	37.8	1	49.9	12	1.01	64.3	62	0.427	9.9
SM6T39A/CA	0.2	1	33.3	37.1	39	41.0	1	53.9	11.1	1.16	69.7	57	0.504	10.0
SM6T56A/CA	0.2	1	47.6	53.2	56	58.8	1	76.6	7.8	2.28	100	40	1.030	10.0
SM6T68A/CA	0.2	1	58.1	64.6	68	71.4	1	92	6.5	3.17	121	33	1.503	10.4
SM6T75A/CA	0.2	1	64.1	71.3	75	78.8	1	103	5.8	4.17	134	30	1.84	10.5
SM6T100A/CA	0.2	1	85.5	95.0	100	105	1	137	4.4	7.27	178	22.5	3.24	10.6
SM6T150A/CA	0.2	1	128	143	150	158	1	207	2.9	16.9	265	15	7.13	10.8
SM6T200A/CA	0.2	1	171	190	200	210	1	274	2.2	29.1	353	11.3	12.7	10.8
SM6T220A/CA	0.2	1	188	209	220	231	1	328	2	48.5	388	10.3	15.2	10.8

1. Pulse test : $t_p < 50\text{ ms}$ 2. To calculate V_{BR} versus junction temperature, use the following formula: $V_{BR} @ T_J = V_{BR} @ 25^{\circ}\text{C} \times (1 + \alpha T \times (T_J - 25))$.3. To calculate maximum clamping voltage at other surge level, use the following formula: $V_{CL} = R_D \times I_{PP} + V_{BRmax}$.

4. Surge capability given for both directions for unidirectional and bidirectional types.

Figure 3. Peak power dissipation versus initial junction temperature

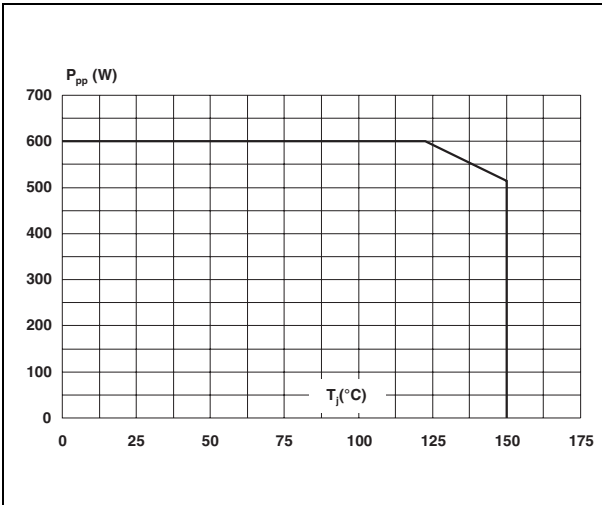


Figure 4. Peak pulse power versus exponential pulse duration

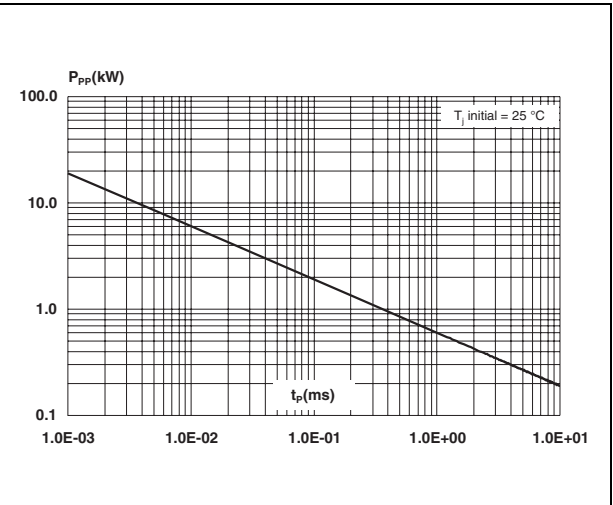


Figure 5. Clamping voltage versus peak pulse current (maximum values)

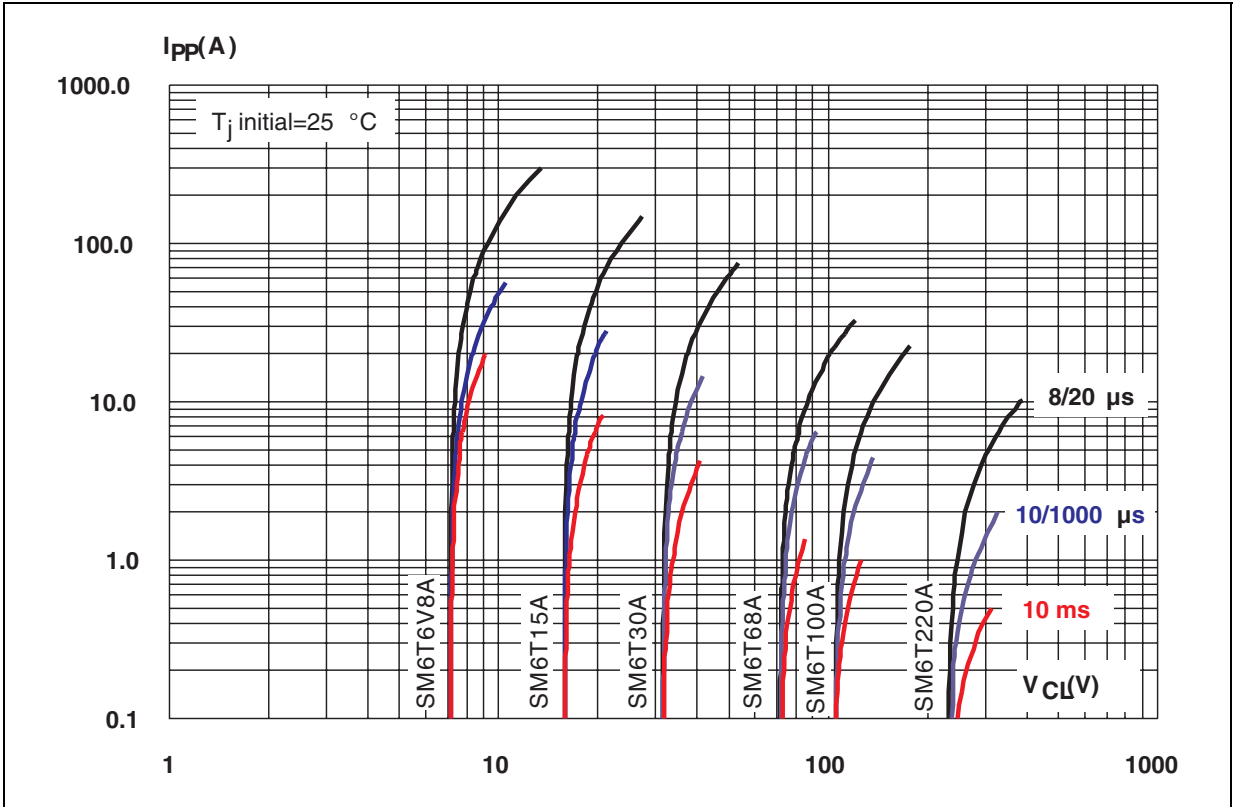


Figure 6. Capacitance versus reverse applied voltage for unidirectional types (typical values)

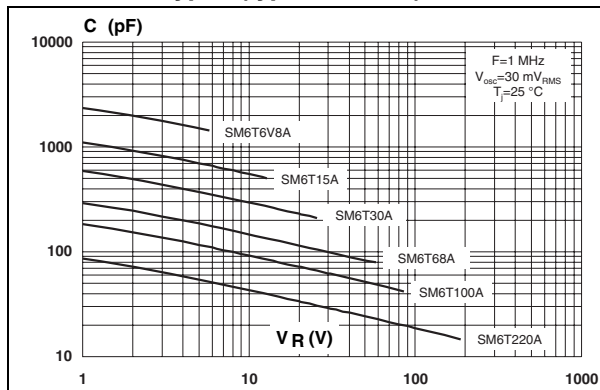


Figure 7. Capacitance versus reverse applied voltage for bidirectional types (typical values)

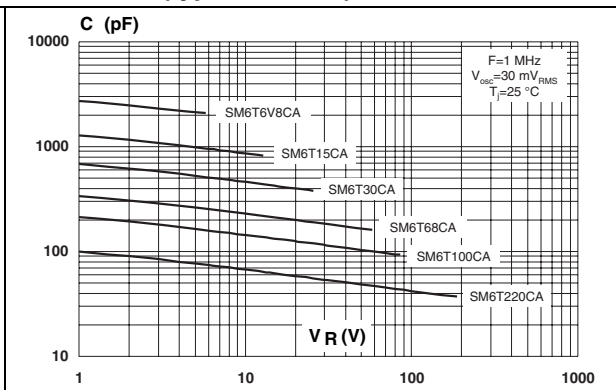


Figure 8. Peak forward voltage drop versus peak forward current (typical values)

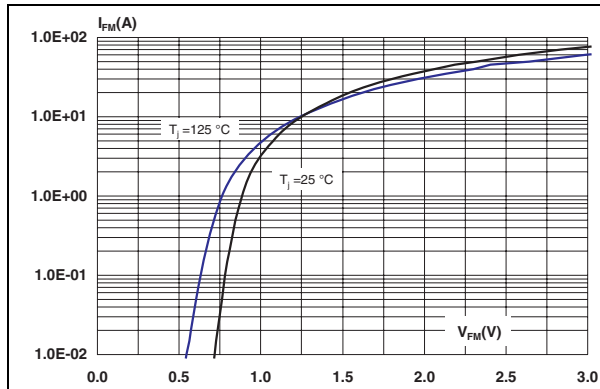


Figure 9. Relative variation of thermal impedance junction to ambient versus pulse duration

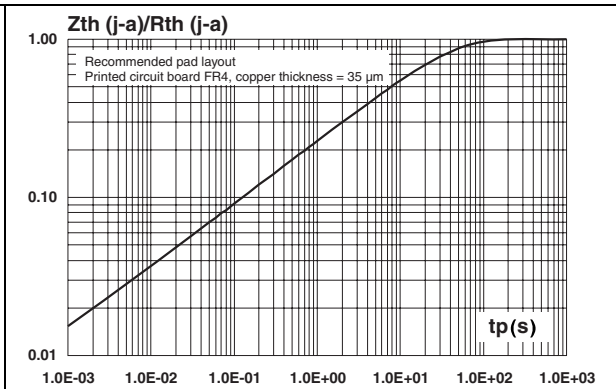


Figure 10. Thermal resistance junction to ambient versus copper surface under each lead

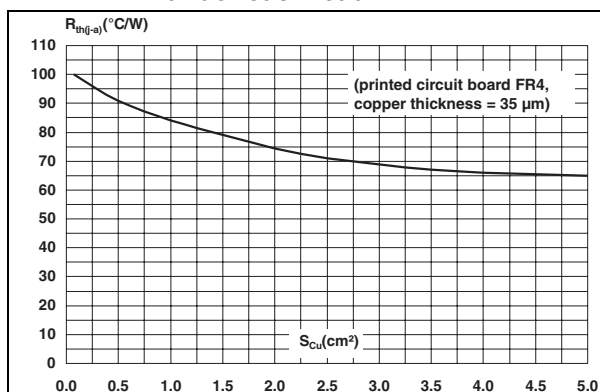
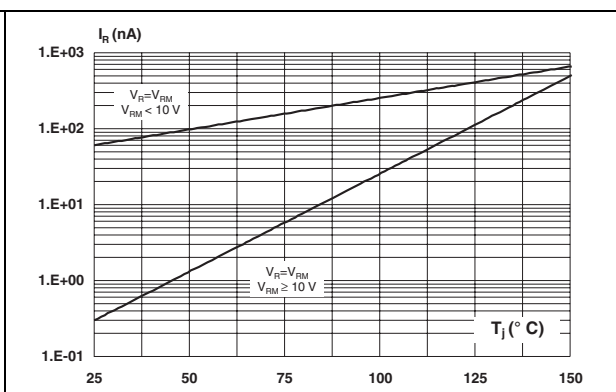
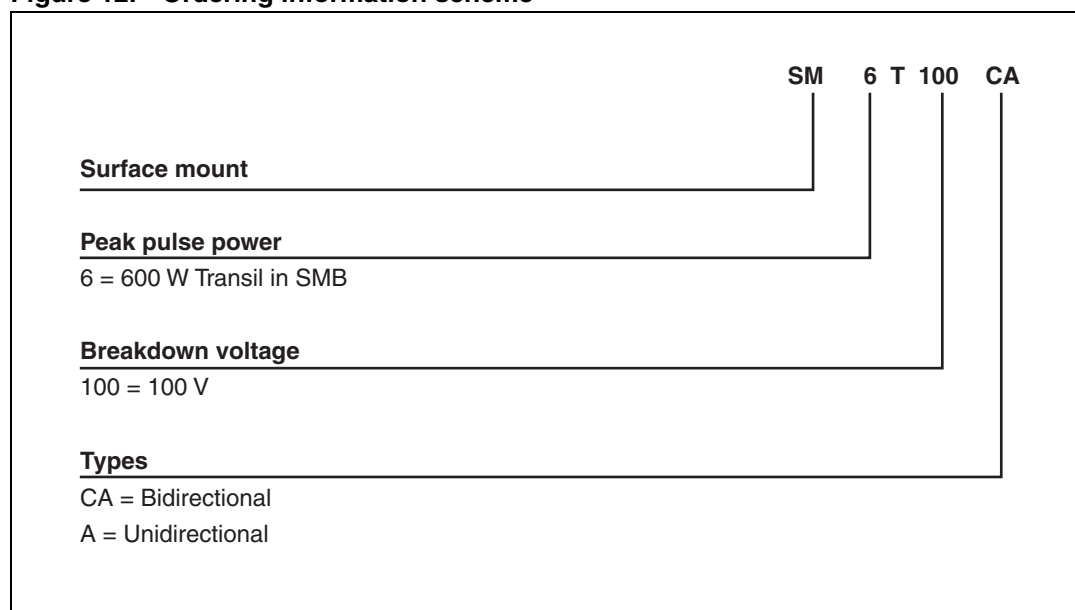


Figure 11. Leakage current versus junction temperature (typical values)



2 Ordering information scheme

Figure 12. Ordering information scheme



3 Packaging information

- Case: JEDEC DO-214AA molded plastic over planar junction
- Terminals: solder plated, solderable as per MIL-STD-750, Method 2026
- Polarity: for unidirectional types the band indicates cathode
- Flammability: epoxy meets UL 94, V0
- RoHS package

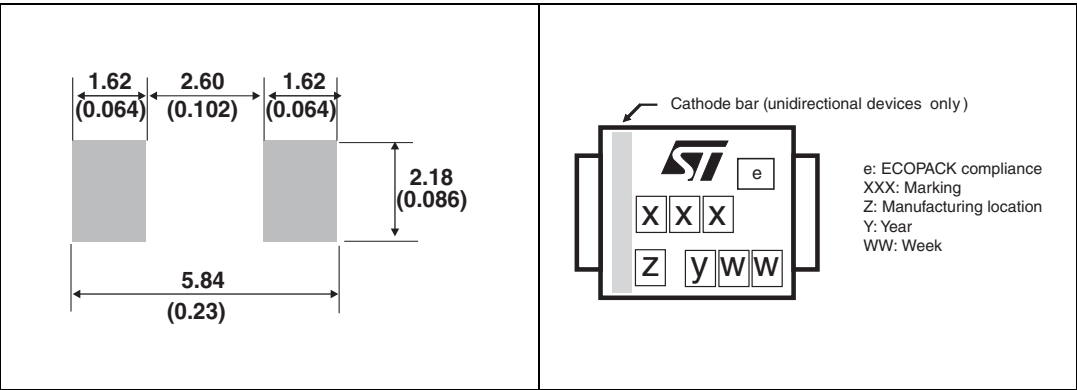
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Table 4. SMB dimensions

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.096
A2	0.05	0.20	0.002	0.008
b	1.95	2.20	0.077	0.087
c	0.15	0.40	0.006	0.016
D	3.30	3.95	0.130	0.156
E	5.10	5.60	0.201	0.220
E1	4.05	4.60	0.159	0.181
L	0.75	1.50	0.030	0.059

Figure 13. SMB footprint dimensions in mm (inches)

Figure 14. Marking layout⁽¹⁾



1. Marking layout can vary according to assembly location.

Table 5. Marking

Order code	Marking	Order code	Marking
SM6T6V8A	DE	SM6T6V8CA	LE
SM6T7V5A	DG	SM6T7V5CA	LG
SM6T10A	DP	SM6T10CA	LP
SM6T12A	DT	SM6T12CA	LT
SM6T15A	DX	SM6T15CA	LX
SM6T18A	EE	SM6T18CA	ME
SM6T22A	EK	SM6T22CA	MK
SM6T24A	EM	SM6T24CA	MM
SM6T27A	EP	SM6T27CA	MP
SM6T30A	ER	SM6T30CA	MR
SM6T33A	ET	SM6T33CA	MT
SM6T36A	EV	SM6T36CA	MV
SM6T39A	EX	SM6T39CA	MX
SM6T56A	FL	SM6T56CA	NL
SM6T68A	FQ	SM6T68CA	NQ
SM6T75A	FS	SM6T75CA	NS
SM6T100A	FY	SM6T100CA	NY
SM6T150A	GL	SM6T150CA	OL
SM6T200A	GU	SM6T200CA	OU
SM6T220A	GW	SM6T220CA	OW

4 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
SM6TxxxA/CA ⁽¹⁾	See Table 5 on page 8	SMB	0.11 g	2500	Tape and reel

1. Where xxx is nominal value of V_{BR} and A or CA indicates unidirectional or bidirectional version. See [Table 3](#) for list of available devices and their order codes

5 Revision history

Table 7. Document revision history

Date	Revision	Changes
August-2001	4A	Previous update.
15-Sep-2004	5	1. Types table parameters on page 2: I_{RM} @ $T_J = 85^\circ\text{C}$ condition added 2. I_{RM} max values changed
26-Mar-2008	6	Reformatted to current standard. SMB dimensions and footprint updated. Maximum junction temperature replaced with operating junction temperature range in Table 1 .
25-May-2009	7	Reformatted to current standard. Added standards compliance information on page 1. Added device SM6T56 to Table 3 . Updated all characteristic curves.
17-Sep-2009	8	Document updated for low leakage current.
20-Oct-2010	9	Updated Figure 13 .

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2010 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com